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September 2015

FDN5632N_F085

N-Channel Logic Level PowerTrench[®] MOSFET 60 V, 1.6 A, 98 m Ω

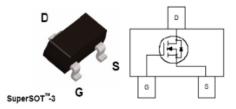
Features

- \blacksquare R_{DS(on)} = 98 m Ω at V_{GS} = 4.5 V, I_D = 1.6 A
- \blacksquare R_{DS(on)} = 82 m Ω at V_{GS} = 10 V, I_D = 1.7 A
- Typ $Q_{g(TOT)}$ = 9.2 nC at V_{GS} = 10 V
- Low Miller Charge
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Applications

- DC/DC converter
- Motor Drives





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V_{DSS}	Drain to Source Voltage	60	V	
V_{GS}	Gate to Source Voltage	±20	V	
1	Drain Current Continuous (V _{GS} = 10V)	1.7	Α	
ID	Pulsed	10	7 ^	
E _{AS}	Single Pulse Avalanche Energy (Note 1)	74	mJ	
P_D	Power Dissipation	1.1	W	
T _J , T _{STG}	Operating and Storage Temperature	-55 to +150	°C	
$R_{\theta JC}$	Thermal Resistance Junction to Case	75	°C/W	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-252, 1in ² copper pad area	111	°C/W	

Note

1: E_{AS} of 74mJ is 100% test at L=80mH, I_{AS} =1.4A, starting T_{J} = 25 $^{\circ}C$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
5632	FDN5632N_F085	SSOT3	7"	8mm	3000 units

Units

Max

Тур

Min

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Parameter

Off Characteristics								
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS}$	= 0V	60	-	-	V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48V,		-	-	1	^	
		$V_{GS} = 0V$	$T_A = 125^{\circ}C$	-	-	250	μА	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA	

Test Conditions

On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1	2.0	3	V
		I _D = 1.7A, V _{GS} = 10V	-	57	82	
		I _D = 1.6A, V _{GS} = 6V	-	62	88	
r _{DS(on)} Drain to Source On Resistance	Drain to Source On Resistance	I _D = 1.6A, V _{GS} = 4.5V		70	98	mΩ
		I _D = 1.7A, V _{GS} = 10V, T _A = 150°C	-	107	135	

Dynamic Characteristics

C _{iss}	Input Capacitance	-V _{DS} = 15V, V _{GS} = 0V, -f = 1MHz		-	475	-	pF
Coss	Output Capacitance			-	60	-	pF
C _{rss}	Reverse Transfer Capacitance			-	30	-	pF
R_{G}	Gate Resistance	f = 1MHz		-	1.4	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	V _{GS} = 0 to 10V	V = 20V	-	9.2	12	nC
Q _{gs}	Gate to Source Gate Charge		$V_{DD} = 20V$ $I_{D} = 1.7A$	-	1.5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	ID - 1.7A		-	1.4	-	nC

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

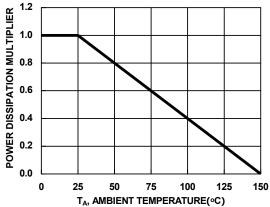
Switching Characteristics

t _{on}	Turn-On Time		-	-	30	ns
t _{d(on)}	Turn-On Delay Time	.,	-	15	-	ns
t _r	Rise Time	$V_{DD} = 30V, I_{D} = 1.0A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$	-	1.7	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, N _{GEN} = 052	-	5.2	-	ns
t _f	Fall Time		-	1.3	-	ns
t _{off}	Turn-Off Time		-	-	12.9	ns

Drain-Source Diode Characteristics

V _{SD}	Source to Drain Diode Voltage	I _{SD} = 1.7A	-	0.8	1.25	V	
		I _{SD} = 0.85A	-	0.8	1.0	v	
t _{rr}	Reverse Recovery Time	I _{SD} = 1.7A, dI _{SD} /dt = 100A/μs	-	16.0	21	ns	
Q _{rr}	Reverse Recovery Charge		-	7.9	10.3	nC	

Typical Characteristics



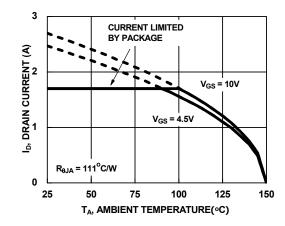


Figure 1. Normalized Power Dissipation vs. Case Temperature

Figure 2. Maximum Continuous Drain Current vs.

Case Temperature

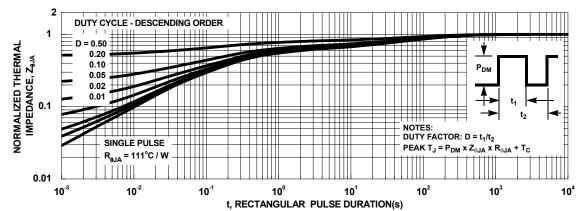


Figure 3. Normalized Maximum Transient Thermal Impedance

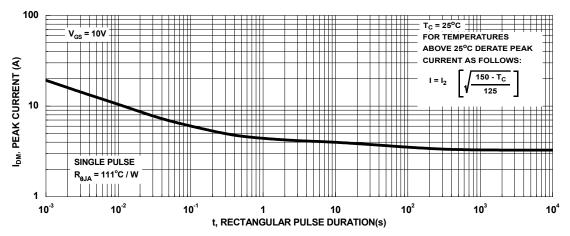


Figure 4. Peak Current Capability

Typical Characteristics

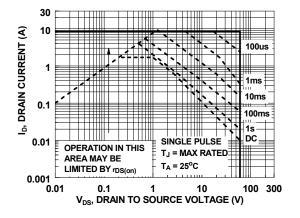
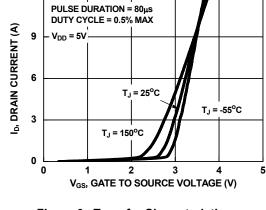


Figure 5. Forward Bias Safe Operating Area



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Figure 6. Transfer Characteristics

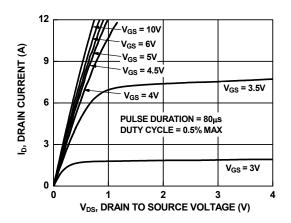


Figure 7. Saturation Characteristics

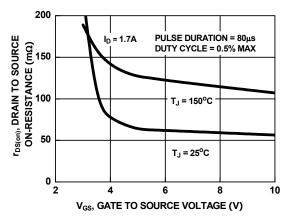


Figure 8. Drain to Source On-Resistance Variation vs Gate to Source Voltage

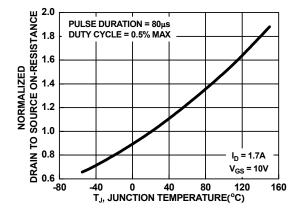


Figure 9. Normalized Drain to Source On Resistance vs Junction Temperature

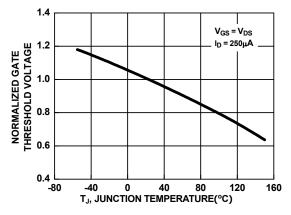


Figure 10. Normalized Gate Threshold Voltage vs Junction Temperature

Typical Characteristics

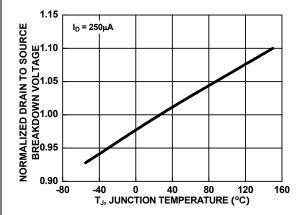


Figure 11. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

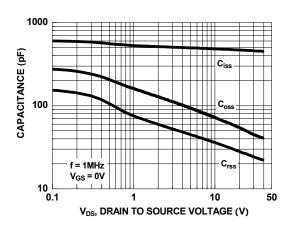


Figure 12. Capacitance vs Drain to Source Voltage

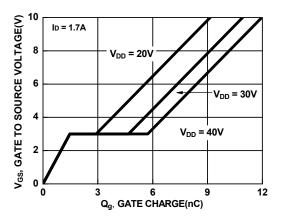
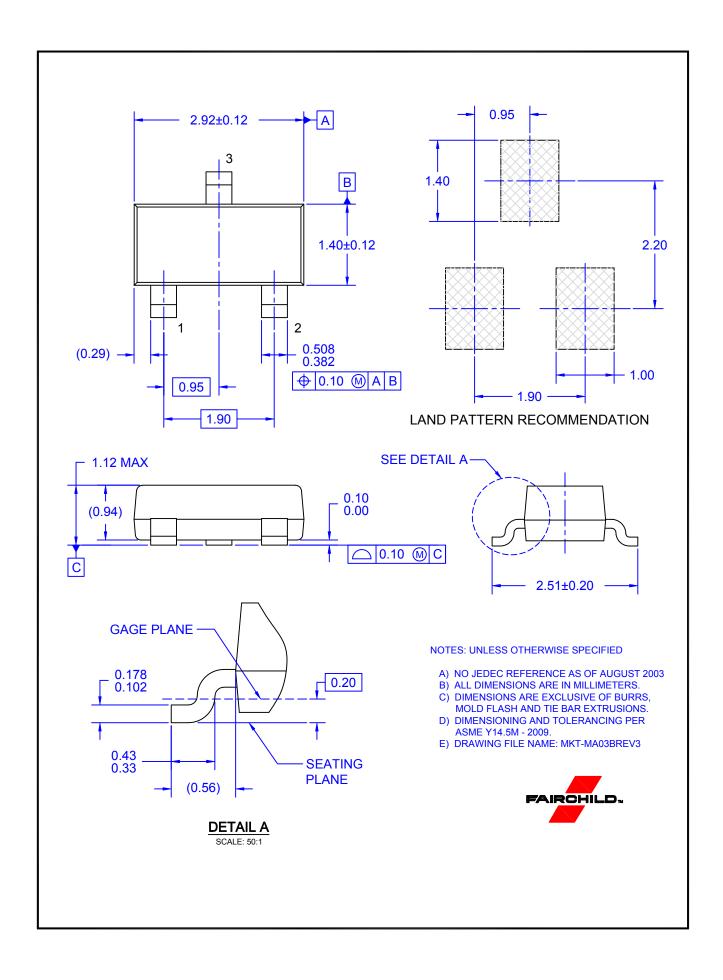


Figure 13. Gate Charge vs Gate to Source Voltage



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